

Title (en)

PROCESS FOR PRODUCING POWDER COATING COMPOSITION

Title (de)

VERFAHREN ZUR HERSTELLUNG EINER PULVERBESCHICHTUNGSZUSAMMENSETZUNG

Title (fr)

PROCÉDÉ POUR PRODUIRE UNE COMPOSITION DE REVÊTEMENT EN POUDRE

Publication

**EP 2399967 B1 20140813 (EN)**

Application

**EP 10743614 A 20100122**

Priority

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- JP 2009037792 A 20090220

Abstract (en)

[origin: EP2399967A1] The present invention is directed to a method of manufacturing a powder coating composition containing thermosetting resin powders to which surface flake pigments have been bonded, and the method includes a first step of preparing the flake pigments having an average particle size not greater than 10 µm or an average thickness not greater than 60 nm, a second step of obtaining a dispersion by dispersing the flake pigments above in a solvent not dissolving the thermosetting resin powders, a third step of obtaining a mixture by mixing the thermosetting resin powders with the dispersion above, and a fourth step of volatilizing and removing the solvent above while the mixture above is stirred.

IPC 8 full level

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